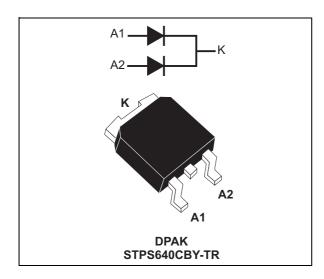
### STPS640C-Y



### Automotive power Schottky rectifier

Datasheet - production data



#### **Features**

- Low forward voltage drop
- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low thermal resistance
- AEC-Q101 qualified.

### **Description**

This dual Schottky rectifier is designed for switch mode power supplies and other power converters.

This device is intended for use in low and medium voltage operation, and in particular high frequency circuits where low switching losses are required (free wheeling and polarity protection) in automotive applications.

**Table 1. Device summary** 

Symbol	Value
I <sub>F(AV)</sub>	2 x 3 A
V <sub>RRM</sub>	40 V
T <sub>j</sub>	150 °C
V <sub>F (Typ)</sub>	0.50 V

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### 1 Characteristics

Table 2. Absolute ratings (limiting values, per diode)

Symbol	Parameter Parameter			Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage			40	V
I <sub>F(RMS)</sub>	Forward rms current			6	Α
1	$I_{F(AV)}$ Average forward current, $\delta = 0.5$ , $T_c = 135$ °C per device		3	Α	
'F(AV)			per device	6	A
I <sub>FSM</sub>	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}, T_c = 25 \text{ °C}$			75	Α
I <sub>RRM</sub>	Peak repetitive reverse current $t_p = 2 \mu s$ , $F = 1 kHz$			1	Α
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 1 \mu s, T_c = 25 \text{ °C}$			1300	W
T <sub>stg</sub>	Storage temperature range			-65 to +150	°C
T <sub>j</sub>	Operating junction temperature			-40 to +150	°C

**Table 3. Thermal parameters** 

Symbol	Parameter	Value	Unit
R. a. s	Junction to case per diode	5.5	
R <sub>th(j-c)</sub>	per device	3	°C/W
R <sub>th(c)</sub>	coupling	0.5	

When the diodes 1 and 2 are used simultaneously :  $\Delta Tj(\mbox{diode 1})$  = P(diode1) x R\_{th(j-c)}(Per diode) + P(diode 2) x R\_{th(c)}

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	Payaraa laakaga aurrant	T <sub>j</sub> = 25 °C	V –V	-	-	100	μΑ
	T <sub>j</sub> = 125 °C	$V_R = V_{RRM}$	-	2	10	mA	
	V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 3 A	-	-	0.63	V
V (2)		T <sub>j</sub> = 125 °C		-	0.50	0.57	
VF 7		T <sub>j</sub> = 25 °C	I <sub>F</sub> = 6 A	-	-	0.84	
		T <sub>j</sub> = 125 °C		-	0.67	0.72	

<sup>1.</sup> Pulse test:  $t_p = 5$  ms,  $\delta < 2\%$ 

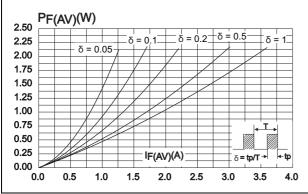
To evaluate the conduction losses use the following equation: P = 0.42 x  $I_{F(AV)}$  + 0.050 x  $I_{F}^{2}_{(RMS)}$ 

<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

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Figure 1. Average forward power dissipation versus average forward current (per diode)

Figure 2. Average forward current versus ambient temperature ( $\delta$  = 0.5, per diode)



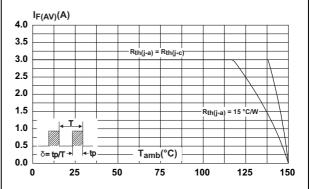
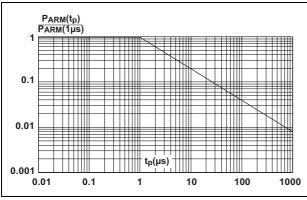


Figure 3. Normalized avalanche power derating versus pulse duration versus junction temperature



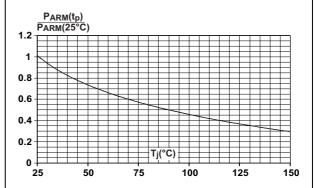
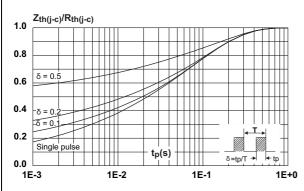
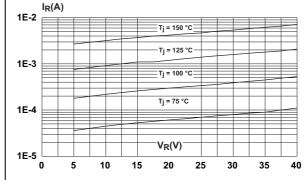


Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

Figure 6. Reverse leakage current vs. reverse voltage applied (typical values, per diode)

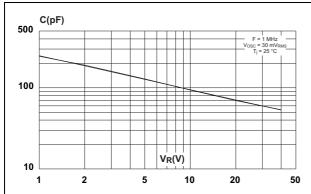




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Figure 7. Junction capacitance vs. reverse voltage applied (typical values, per diode)

Figure 8. Forward voltage drop vs. forward current (per diode)



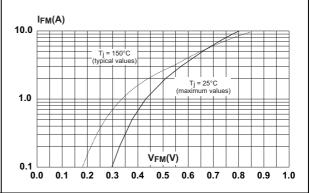
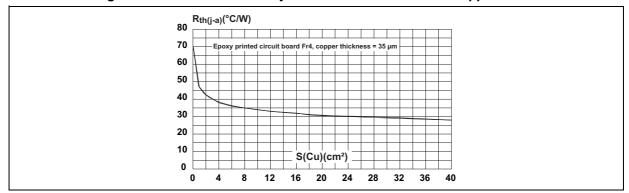


Figure 9. Thermal resistance junction to ambient versus copper surface under tab



### 2 Package information

- Epoxy meets UL94,V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.

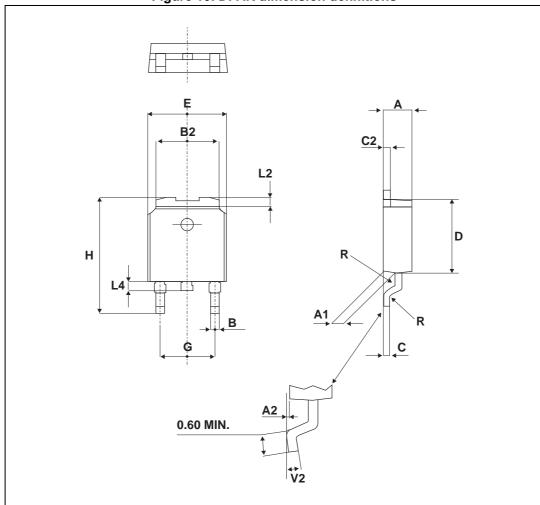


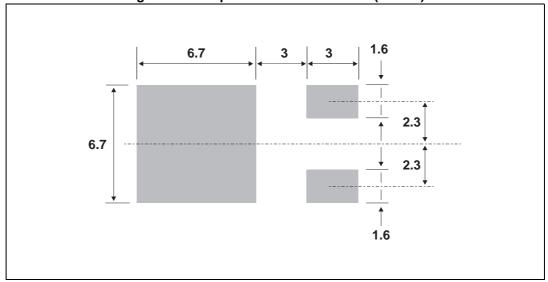
Figure 10. DPAK dimension definitions

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**Table 5. DPAK dimension values** 

		Dimensions						
Ref.		Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
Α	2.20		2.40	0.086		0.094		
A1	0.90		1.10	0.035		0.043		
A2	0.03		0.23	0.001		0.009		
В	0.64		0.90	0.025		0.035		
B2	5.20		5.40	0.204		0.212		
С	0.45		0.60	0.017		0.023		
C2	0.48		0.60	0.018		0.023		
D	6.00		6.20	0.236		0.244		
E	6.40		6.60	0.251		0.259		
G	4.40		4.60	0.173		0.181		
Н	9.35		10.10	0.368		0.397		
L2		0.80 typ.			0.031 typ.			
L4	0.60		1.00	0.023		0.039		
V2	0°		8°	0°		8°		

Figure 11. Footprint dimensions in mm (inches)



# 3 Ordering information

**Table 6. Ordering information** 

Order code	Marking	Package Weigh		Base qty	Delivery mode
STPS640CBY-TR	STPS640CY	DPAK	0.3 g	2500	Tape and reel

## 4 Revision history

Table 7. Revision history

Date	Revision	Changes
6-Nov-2013	1	First issue
04-Dec-2013	2	Properties changed from preliminary data to production data.

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